PNA1605F (PN116)

Silicon planar type

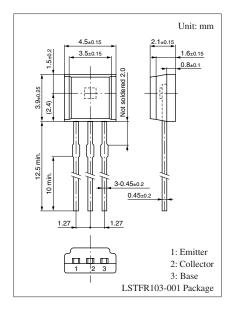
For optical control systems

■ Features

- High sensitivity
- Wide directivity characteristics, suited for detecting GaAs LEDs: $\theta = 70^{\circ}$ (typ.)
- Fast response: t_r , $t_f = 8 \mu s$ (typ.)
- Side-view type package

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-emitter voltage (Base open)	V _{CEO}	20	V	
Collector-base voltage (Emitter open)	V_{CBO}	30	V	
Emitter-collector voltage (Base open)	V _{ECO}	5	V	
Emitter-base voltage (Collector open)	V_{EBO}	5	V	
Collector current	I_C	10	mA	
Collector power dissipation	P _C	100	mW	
Operating ambient temperature	T_{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

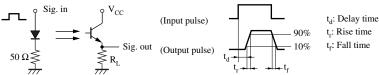


■ Electrical-Optical Characteristics $T_a = 25$ °C ± 3 °C

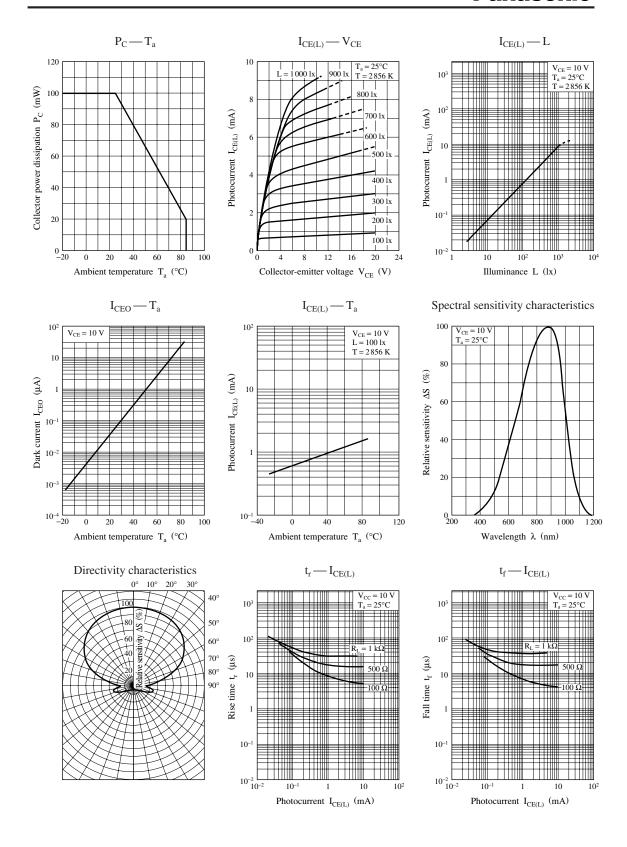
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Photocurrent *1	I _{CE(L)}	$V_{CE} = 10 \text{ V}, L = 100 \text{ lx}$	0.2	0.8		mA
Dark current	I_{CEO}	$V_{CE} = 10 \text{ V}$		0.05	2.00	μΑ
Peak emission wavelength	λ_{p}	$V_{CE} = 10 \text{ V}$		900		nm
Half-power angle	θ	The angle from which photocurrent becomes 50%		70		0
Rise time *2	t _r	$V_{CC} = 10 \text{ V}, I_{CE(L)} = 1 \text{ mA}, R_L = 100 \Omega$		8		μs
Fall time *2	t _f			9		μs
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_{CE(L)} = 1 \text{ mA}, L = 1000 \text{ lx}$		0.3	0.6	V

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

- 2. *1: Source: Tungsten (color temperature 2856 K)
 - *2: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.



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